## **IGBT - Field Stop**

600 V, 60 A

## FGH60N60SFD

#### Description

Using novel field stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.

#### Features

- High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)} = 2.3 \text{ V} @ I_C = 60 \text{ A}$
- High Input Impedance
- Fast Switching
- This Device is Pb-Free and is RoHS Compliant

### Applications

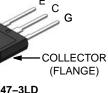
• Solar Inverter, UPS, Welder, PFC



## **ON Semiconductor®**

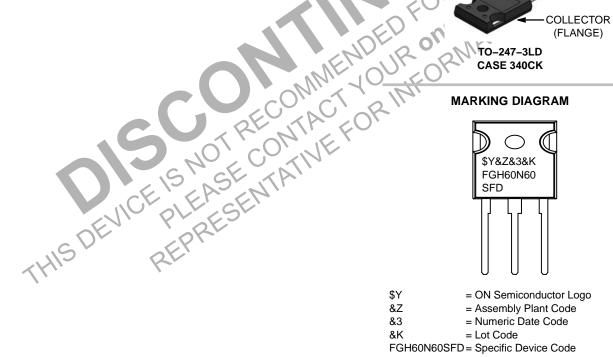
www.onsemi.com

Со



TO-247-3LD CASE 340CK

### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

Desc	Description			Unit
Collector to Emitter Voltage	V <sub>CES</sub>	600	V	
Gate to Emitter Voltage		V <sub>GES</sub>	±20	V
Transient Gate-to-Emitter Voltage		1	±30	1
Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	Ι <sub>C</sub>	120	А
Collector Current	T <sub>C</sub> = 100°C		60	А
Pulsed Collector Current	$T_{\rm C} = 25^{\circ}{\rm C}$	I <sub>CM</sub> (Note 1)	180	А
Maximum Power Dissipation	$T_{C} = 25^{\circ}C$	PD	378	W
Maximum Power Dissipation	T <sub>C</sub> = 100°C		151	W
Operating Junction Temperature		TJ	-55 to +150	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C	
Maximum Lead Temp. for Soldering Pu	rposes, 1/8" from Case for 5 Seconds	TL	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. -IN DES

1. Repetitive test, Pulse width limited by max. junction temperature.

#### THERMAL CHARACTERISTICS

Parameter	Symbol	Тур	Max	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub> (IGBT)		0.33	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$ (Diode)		10	°C/W
Thermal Resistance, Junction to Ambient	R <sub>θJA</sub>	Fr - 02	40	°C/W

# PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH60N60SFDTU	FGH60N60SFD	TO-247	Tube	N/A	N/A	30

## ELECTRICAL CHARACTERISTICS OF THE IGBT (T<sub>C</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS	51	(F				
Collector to Emitter Breakdown Voltage	BVCES	$V_{GE}$ = 0 V, $I_C$ = 250 $\mu A$	600	-	-	V
Temperature Coefficient of Breakdown Voltage	V <sub>CES</sub> /∆T <sub>J</sub>	$V_{GE} = 0 \text{ V}, I_{C} = 250 \ \mu\text{A}$	-	0.4	-	V/°C
Collector Cut-Off Current	I <sub>CES</sub>	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μΑ
G-E Leakage Current	I <sub>GES</sub>	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA

## **ON CHARACTERISTICs**

G–E Threshold Voltage	V <sub>GE(th)</sub>	$I_C = 250 \ \mu\text{A}, \ V_{CE} = V_{GE}$	4.0	5.0	6.5	V
Collector to Emitter Saturation Voltage	V <sub>CE(sat)</sub>	$I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V}$	-	2.3	2.9	V
		$I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	2.5	-	V

#### **ELECTRICAL CHARACTERISTICS OF THE IGBT** ( $T_C = 25^{\circ}C$ unless otherwise noted) (continued)

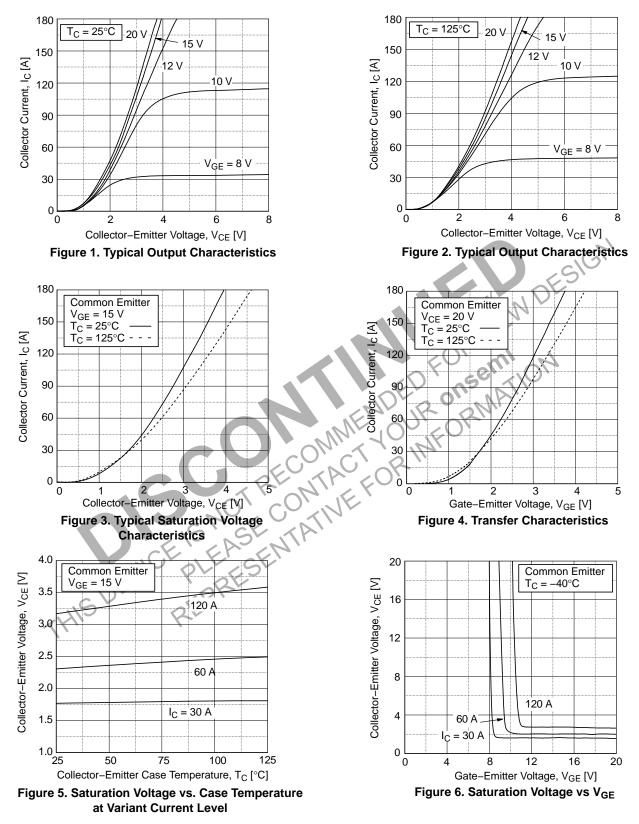
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS		•				
Input Capacitance	C <sub>ies</sub>	$V_{CE}$ = 30 V, $V_{GE}$ = 0 V, f = 1 MHz	-	2820	_	pF
Output Capacitance	C <sub>oes</sub>	7	_	350	_	pF
Reverse Transfer Capacitance	C <sub>res</sub>	7	-	140	-	pF
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 60 \text{ A},$	-	22	-	ns
Rise Time	t <sub>r</sub>	$R_G = 5 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_C = 25^{\circ}C$	-	42	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	]	-	134	-	ns
Fall Time	t <sub>f</sub>	7	-	31	62	ns
Turn–On Switching Loss	E <sub>on</sub>	7	_	1.79	_	mJ
Turn–Off Switching Loss	E <sub>off</sub>		-	0.67	-	mJ
Total Switching Loss	E <sub>ts</sub>			2.46	GN	mJ
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 60 \text{ A},$	-	22	<u> </u>	ns
Rise Time	t <sub>r</sub>	$R_G = 5 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_C = 125$ °C	-	44	_	ns
Turn-Off Delay Time	t <sub>d(off)</sub>		EV	144	-	ns
Fall Time	t <sub>f</sub>		4	43	_	ns
Turn–On Switching Loss	E <sub>on</sub>	EOr	1	1.88	_	mJ
Turn–Off Switching Loss	E <sub>off</sub>		6-1	1.0	_	mJ
Total Switching Loss	E <sub>ts</sub>	DE ON	Vb,	2.88	_	mJ
Total Gate Charge	Qg	$V_{CE} = 400 \text{ V}, 1_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V}$	_	198	_	nC
Gate to Emitter Charge	Q <sub>ge</sub>	MAILYONFO	_	22	_	nC
Gate to Collector Charge	Q <sub>gc</sub>		-	106	-	nC

## ELECTRICAL CHARACTERISTICS OF THE DIODE (T<sub>J</sub> = 25°C unless otherwise noted)

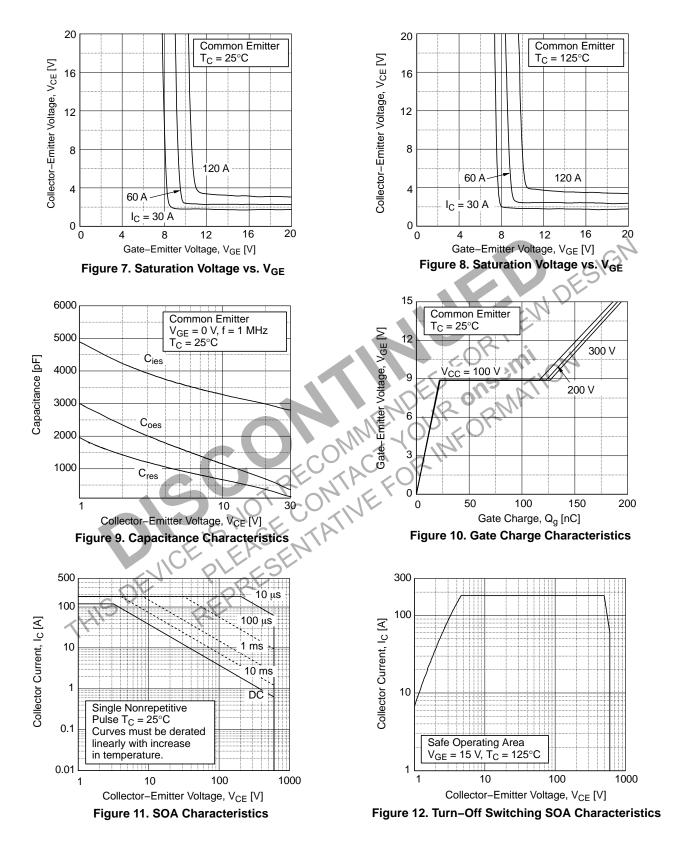
Symbol	Parameter	Test Condition	IS	Min	Тур	Max	Unit
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 30 A	$T_C = 25^{\circ}C$	-	2.0	2.6	V
		F	T <sub>C</sub> = 125°C	_	1.8	-	
t <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>F</sub> = 30 A, di <sub>F</sub> /dt = 200 A/μs	$T_C = 25^{\circ}C$	-	47	-	ns
	SV SER		T <sub>C</sub> = 125°C	-	179	-	
Q <sub>rr</sub>	Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$	_	83	-	nC
			T <sub>C</sub> = 125°C	_	567	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

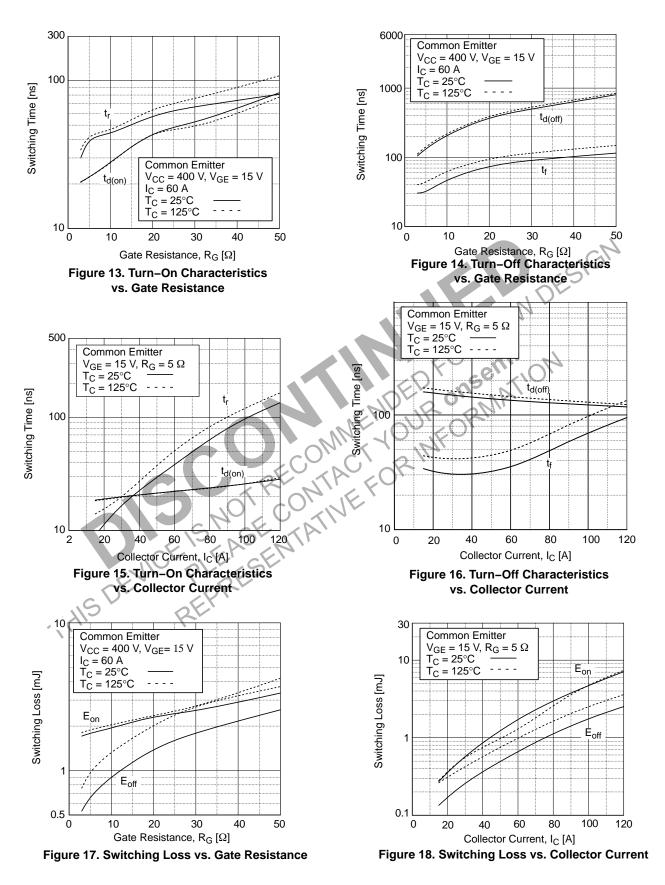
## **TYPICAL PERFORMANCE CHARACTERISTICS**



## TYPICAL PERFORMANCE CHARACTERISTICS (continued)



## TYPICAL PERFORMANCE CHARACTERISTICS (continued)



## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

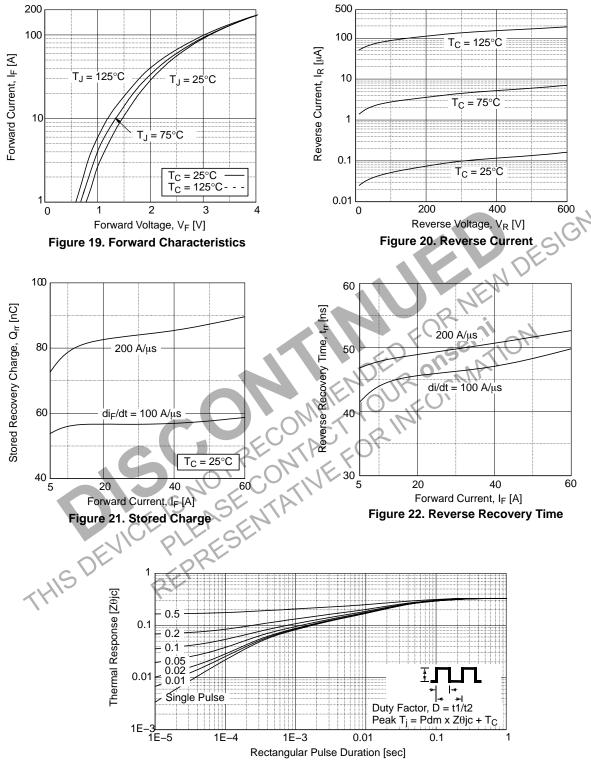
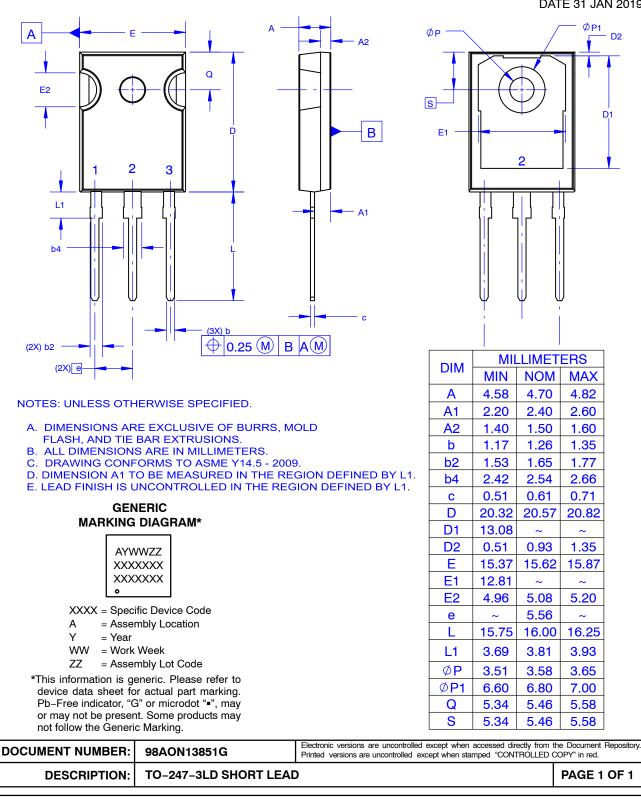


Figure 23. Transient Thermal Impedance of IGBT



TO-247-3LD SHORT LEAD CASE 340CK **ISSUE A** 

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